B10G3741N55D

LDMOS 3-stage integrated Doherty MMIC

AMPLEON

Rev. 2 — 16 April 2021

Product data sheet

1. Product profile

1.1 General description

The B10G3741N55D is a 3-stage fully integrated asymmetrical Doherty MMIC solution using Ampleon's state of the art GEN10 LDMOS technology. The carrier and peaking device, input splitter, output combiner and pre-match are integrated in a single package. This multiband device is perfectly suited as a final stage for small cells and massive MIMO applications in the frequency range from 3700 MHz to 4100 MHz. Available in PQFN outline.

Table 1. Application performance

Typical RF performance at $T_{case} = 25$ °C; $I_{Dq} = 73$ mA (carrier and peaking); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.4$ V. Test signal: 1-carrier LTE 20 MHz; PAR = 7.6 dB at 0.01 % probability CCDF; measured in an Ampleon f = 3700 MHz to 4100 MHz integrated Doherty application circuit.

| Test signal | f | V _{DS} | P _{L(AV)} | G _p | $\eta_{\mathbf{D}}$ |
|--|-------|-----------------|--------------------|----------------|---------------------|
| | (MHz) | (V) | (W) | (dB) | (%) |
| 1-carrier LTE 20 MHz (3900 MHz) PAR = 7.6 dB | 3900 | 28 | 7.94 | 34.8 | 37 |

1.2 Features and benefits

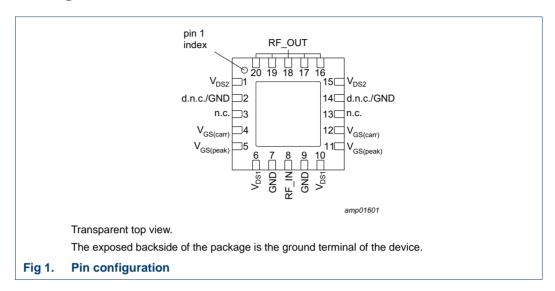
- Integrated input splitter
- Integrated output combiner
- lacksquare 30 Ω output impedance thanks to integrated pre-match
- Very high efficiency thanks to asymmetry
- Designed for wideband operation (frequency 3700 MHz to 4100 MHz)
- Independent control of carrier and peaking bias
- Integrated ESD protection
- Source impedance 50 Ω ; high power gain
- For RoHS compliance see the product details on the Ampleon website

1.3 Applications

■ RF power MMIC for multi-carrier and multi-standard 5G, W-CDMA and LTE base stations in the 3700 MHz to 4100 MHz frequency range

2. Pinning information

2.1 Pinning



2.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------------|-----|---------------------------------------|
| V_{DS2} | 1 | drain-source voltage of final stages |
| d.n.c./GND | 2 | do not connect or GND |
| n.c. | 3 | not connected |
| V _{GS(carr)} | 4 | gate-source voltage of carrier |
| V _{GS(peak)} | 5 | gate-source voltage of peaking |
| V _{DS1} | 6 | drain-source voltage of driver stages |
| GND | 7 | RF ground |
| RF_IN | 8 | RF input |
| GND | 9 | RF ground |
| V _{DS1} | 10 | drain-source voltage of driver stages |
| V _{GS(peak)} | 11 | gate-source voltage of peaking |
| V _{GS(carr)} | 12 | gate-source voltage of carrier |
| n.c. | 13 | not connected |
| d.n.c./GND | 14 | do not connect or GND |
| V_{DS2} | 15 | drain-source voltage of final stages |
| RF_OUT | 16 | RF output |
| RF_OUT | 17 | RF output |
| RF_OUT | 18 | RF output |
| RF_OUT | 19 | RF output |
| RF_OUT | 20 | RF output |

Table 2. Pin description ... continued

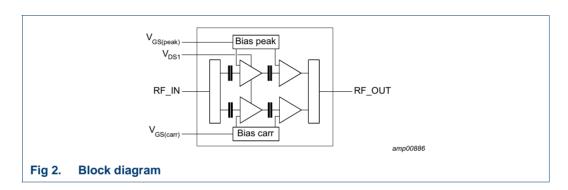
| Symbol | Pin | Description |
|--------|--------|-------------|
| GND | flange | RF ground |

3. Ordering information

Table 3. Ordering information

| Package name | Orderable part number | 12NC | 3 | Min. orderable quantity (pieces) |
|--------------|-----------------------|----------------|---------------------------------|----------------------------------|
| SOT1462-1 | B10G3741N55DZ | 9349 604 16515 | TR13; 500-fold; 16 mm; dry pack | 500 |

4. Block diagram



5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|----------------------|------------|-----|------|------|
| V_{DS} | drain-source voltage | | - | 65 | V |
| V_{GS} | gate-source voltage | | -6 | +13 | V |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | [1] | - | 200 | °C |

^[1] Continuous use at maximum temperature will affect the reliability. For details refer to the online MTF calculator.

6. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Value | Unit |
|----------------------|-------------------------------------|--|-------|------|
| R _{th(j-c)} | thermal resistance from junction to | $T_{case} = 90 ^{\circ}C; P_{L} = 8 W$ [1] | 2.75 | K/W |
| | case | $T_{case} = 90 ^{\circ}C; P_{L} = 10 W$ [1] | 2.45 | K/W |

^[1] When operated with a 1-carrier W-CDMA with PAR = 9.9 dB at 3800 MHz.

Characteristics

Table 6. **DC** characteristics

 $T_{\rm case} = 25 \, {}^{\circ}{\rm C}.$

| Symbol Parameter | | Conditions | Min | Тур | Max | Unit | | |
|------------------|-------------------------------|--|-----|-----|------|------|--|--|
| Carrier | | | | | | | | |
| V_{GSq} | gate-source quiescent voltage | V _{DS} = 28 V; I _D = 70 mA | 1.8 | 2.1 | 2.55 | V | | |
| I _{GSS} | gate leakage current | V _{GS} = 9 V; V _{DS} = 0 V | - | - | 140 | nA | | |
| Peaking | | | · | | · | | | |
| I _{GSS} | gate leakage current | V _{GS} = 9 V; V _{DS} = 0 V | - | - | 140 | nA | | |
| Final sta | iges | | · | | · | | | |
| I _{DSS} | drain leakage current | V _{GS} = 0 V; V _{DS} = 28 V | - | - | 1.4 | μΑ | | |
| Driver st | Driver stages | | | | | | | |
| I _{DSS} | drain leakage current | V _{GS} = 0 V; V _{DS} = 28 V | - | - | 1.4 | μΑ | | |

RF Characteristics Table 7.

Typical RF performance at T_{case} = 25 °C; V_{DS} = 28 V; I_{Dq} = 70 mA (carrier); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.5$ V; P_L = 39 dBm. Test signal: pulsed CW [1]; f = 3900 MHz measured in an Ampleon production circuit.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------|-------------------|----------------------------------|------|------|------|------|
| Gp | power gain | | 32.7 | 34.7 | 36.7 | dB |
| η_{D} | drain efficiency | P _L = 7.94 W (39 dBm) | 35 | 41 | - | % |
| | | $P_L = P_{L(3dB)}$ | 38 | 42 | - | % |
| RLin | input return loss | | - | - | -10 | dB |
| $P_{L(M)}$ | peak output power | | 46.8 | 47.6 | - | dBm |

^[1] Pulsed CW power sweeps measurement (δ = 10 %; t_p = 100 μ s).

8. Application information

Table 8. Typical performance

 $T_{case} = 25$ °C; $V_{DS} = 28$ V; $I_{Dq} = 73$ mA (driver and final stages); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.4$ V. Test signal: 1-carrier LTE 20 MHz; PAR = 7.6 dB at 0.01 % probability CCDF; measured in an Ampleon f = 3700 MHz to 4100 MHz frequency band symmetrical integrated Doherty application circuit.

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-------------------------------|---------------------------------------|--|-----|-----|-------|-----|-------|
| P _{L(3dB)} | output power at 3 dB gain compression | f = 3900 MHz | [1] | - | 47 | - | dBm |
| $\phi_{s21}/\phi_{s21(norm)}$ | normalized phase response | at 3 dB compression point; f = 3900 MHz | [2] | - | -63 | - | 0 |
| η_{D} | drain efficiency | 8 dB OBO (P _{L(AV)} = 39 dBm); f = 3900 MHz | | - | 36.6 | - | % |
| Gp | power gain | P _{L(AV)} = 39 dBm; f = 3900 MHz | | - | 34.8 | - | dB |
| B _{video} | video bandwidth | P _{L(AV)} = 37 dBm; 2-tone CW; f = 3900 MHz | | - | 400 | - | MHz |
| G _{flat} | gain flatness | P _{L(AV)} = 39 dBm; f = 3900 MHz to 4100 MHz | | - | 2.9 | - | dB |
| ΔG/ΔΤ | gain variation with temperature | f = 3900 MHz | [3] | - | 0.056 | - | dB/°C |
| ACPR _{20M} | adjacent channel power ratio (20 MHz) | P _{L(AV)} = 39 dBm; f = 3900 MHz | | - | -25.3 | - | dBc |
| K | Rollett stability factor | T_{case} = -40 °C to 125 °C; f = 0.5 GHz to 6.1 GHz | [3] | - | >1.5 | - | |

^[1] Pulsed CW power sweeps measurement (δ = 10 %; t_p = 100 μ s).

^{[2] 25} ms CW power sweep measurement.

^[3] For both sections (S-parameters measured with broadband demo board).

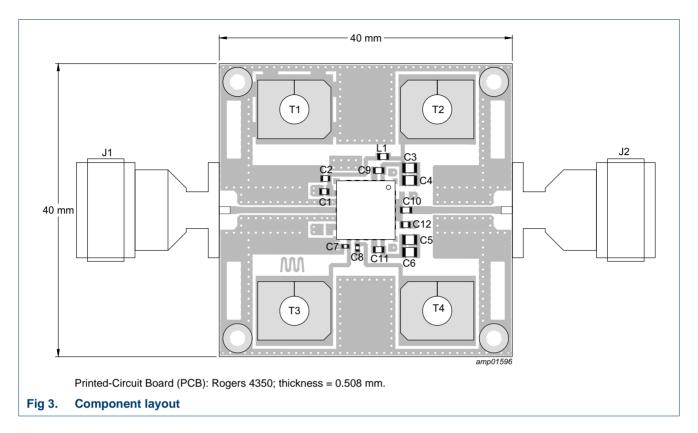
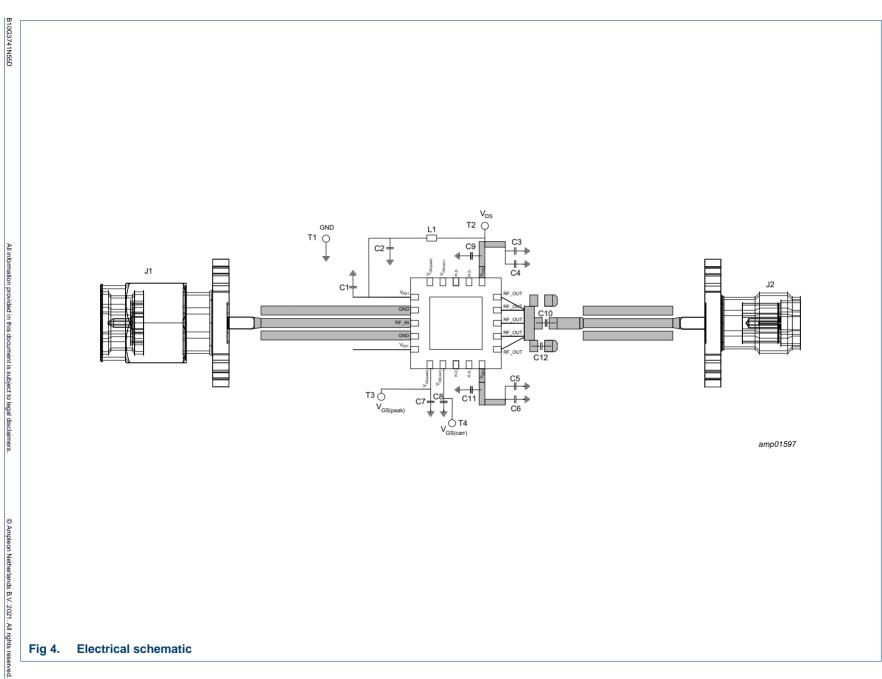


Table 9.Demo test circuit list of componentsSee Figure 3 for component layout.

| Component | Description | Value | Remarks |
|----------------|------------------------------------|------------------------------|-------------------------------------|
| C1 | multilayer ceramic chip capacitor | 15 nF, 50 V | Murata: 06035C153KAZ2A |
| C2 | multilayer ceramic chip capacitor | 100 nF, 50 V | Murata: 06035C104KAT2A |
| C3, C4, C5, C6 | multilayer ceramic chip capacitor | 10 μF, 50 V | Murata: GRM21BR6YA106KE43 |
| C7, C8 | multilayer ceramic chip capacitor | 4.7 μF, 6.3 V | Murata: GRM155R60J475ME47D |
| C9 | multilayer ceramic chip capacitor | 3 pF \pm 0.1 % | Murata: GQM1875C2E3R0BB12 |
| C10 | multilayer ceramic chip capacitor | 1.6 pF ± 0.1 % | Murata: GQM1875C2E1R6BB12 |
| C11 | SMA Coaxial panel connector male | 3 pF | Murata: GQM1875C2E3R0BB12 |
| C12 | SMA Coaxial panel connector female | 0.1 pF | Murata: GQM1875CER10BB12 |
| L1 | ferrite bead | 420 Ω at 700 MHz [1] | Murata: BLF03JD421GZE |
| J1 | SMA Coaxial panel connector male | | Huber & Suhner: 13_SMA-50-0-2/111_N |
| J2 | SMA Coaxial panel connector female | | Huber & Suhner: 23_SMA-50-0-2/111_N |
| T1, T2, T3, T4 | PCB Terminal | 6.35 mm × 0.81 mm, 4.1 mm | TE connectivity |

^[1] It is strongly recommended to use L1.



Product data sheet

8.1 Ruggedness in a Doherty operation

The B10G3741N55D is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 32 V; I_{Dq} = 70 mA (carrier); P_i corresponding to $P_{L(3dB)}$ – 5 dB under Z_S = 50 Ω load; f = 4100 MHz (1-carrier W-CDMA PAR 9.9 signal is used during the stress); T_{case} = 25 °C.

8.2 Impedance information

Table 10. Typical impedance for optimum Doherty operation

Measured load-pull data; test signal: pulsed CW; $T_{\rm case} = 25$ °C; $V_{\rm DS} = 28$ V; $I_{\rm Dq} = 70$ mA (carrier); $V_{\rm GSq(peaking)} = V_{\rm GSq(carrier)} - 0.5$ V; $t_{\rm p} = 100$ μ s; $\delta = 10$ %.

| 70 | | | | | | | | | |
|-------|---------------------|------------------------------------|---------------------|----------------------|----------------------|--|--|--|--|
| | tuned for optimun | uned for optimum Doherty operation | | | | | | | |
| f | Z _L [1] | P _{L(3dB)} | G _{p(max)} | η _{add} [2] | η _{add} [3] | | | | |
| (MHz) | (Ω) | (dBm) | (dB) | (%) | (%) | | | | |
| 3600 | 24.78 – j16.91 | 47.69 | 34.77 | 39.50 | 41.24 | | | | |
| 3700 | 23.44 – j16.21 | 47.70 | 35.54 | 40.41 | 40.60 | | | | |
| 3800 | 24.52 – j17.91 | 47.65 | 35.85 | 40.48 | 40.48 | | | | |
| 3900 | 27.03 – j18.57 | 47.68 | 36.35 | 41.97 | 39.82 | | | | |
| 4000 | 28.32 – j17.21 | 47.67 | 36.43 | 43.98 | 38.49 | | | | |
| 4100 | 28.40 - j14.33 | 47.62 | 36.13 | 44.58 | 37.19 | | | | |
| 4200 | 25.82 – j11.16 | 47.40 | 36.06 | 45.92 | 35.70 | | | | |

^[1] Reference package plane.

^[2] At P_{L(3dB)}.

^[3] At 39 dBm.

9. Package outline

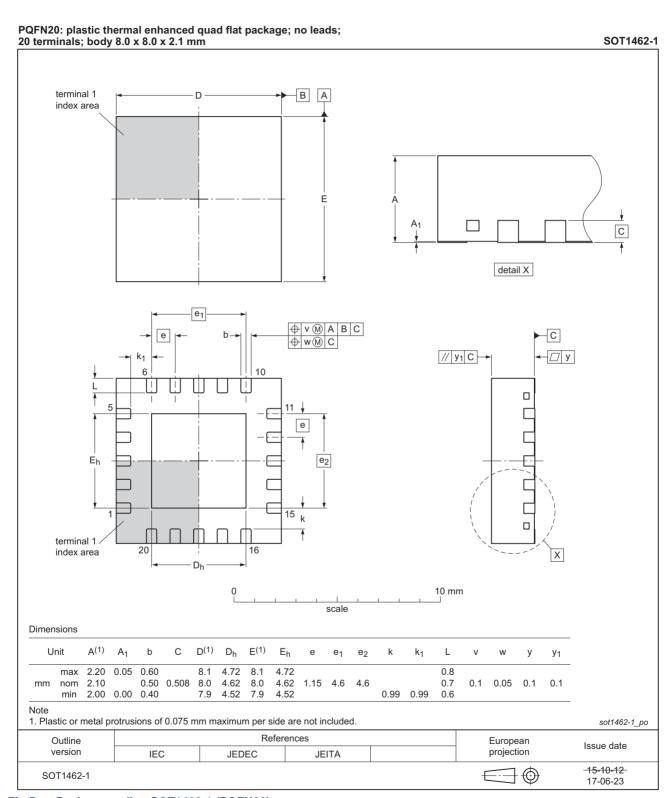


Fig 5. Package outline SOT1462-1 (PQFN20)

10. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 11. ESD sensitivity

| ESD model | Class |
|--|---------|
| Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002 | C2A [1] |
| Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001 | 1C 2 |

- [1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V.
- [2] HBM classification 1C is granted to any part that passes after exposure to an ESD pulse of 1000 V.

11. Abbreviations

Table 12. Abbreviations

| Acronym | Description |
|---------|--|
| 5G | Fifth Generation |
| CCDF | Complementary Cumulative Distribution Function |
| CW | Continuous Wave |
| ESD | ElectroStatic Discharge |
| GEN10 | Tenth Generation |
| LDMOS | Laterally Diffused Metal Oxide Semiconductor |
| LTE | Long Term Evolution |
| MMIC | Monolithic Microwave Integrated Circuit |
| MIMO | Multiple Input Multiple Output |
| MTF | Median Time to Failure |
| ОВО | Output Back Off |
| PAR | Peak-to-Average Ratio |
| RoHS | Restriction of Hazardous Substances |
| VSWR | Voltage Standing Wave Ratio |
| W-CDMA | Wideband Code Division Multiple Access |

12. Revision history

Table 13. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | |
|------------------|--|------------------------------------|---------------|------------------|--|
| B10G3741N55D v.2 | 20210416 | Product data sheet | - | B10G3741N55D v.1 | |
| Modifications: | • Figure 3 o | Figure 3 on page 6: figure updated | | | |
| | • <u>Table 9 on page 6</u> : table updated | | | | |
| | • Figure 4 on page 7: figure updated | | | | |
| B10G3741N55D v.1 | 20210330 | Product data sheet | - | - | |

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| Document status[1][2] | Product status[3] | Definition | | |
|--------------------------------|-------------------|---|--|--|
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| Preliminary [short] data sheet | Qualification | ualification This document contains data from the preliminary specification. | | |
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